

Title (en)

Floor panel with connecting means for mechanical joining and with elastic compensation means

Title (de)

Bodenplatte mit Verbindungsmitteln zur mechanischen Verbindung und mit elastischen Ausgleichmitteln

Title (fr)

Panneau de plancher avec des moyens d'assemblage pour liaison mécanique et des moyens élastiques de compensation

Publication

EP 1412596 A1 20040428 (EN)

Application

EP 02749499 A 20020729

Priority

- SE 0201417 W 20020729
- SE 0102620 A 20010727

Abstract (en)

[origin: WO03012224A1] Floor panels and floor elements therefore are made of sheet-shaped cores (30) which before application of the surface layer (31) of the floor panels are formed with sealing means (20, 52, 57) for counteracting changes, caused by moisture, of the properties of the floor panels.

IPC 1-7

E04F 15/04

IPC 8 full level

E04F 15/04 (2006.01); **E04F 15/18** (2006.01); **B27M 3/04** (2006.01); **E04F 15/02** (2006.01)

CPC (source: EP KR)

E04F 15/02016 (2013.01 - EP); **E04F 15/02033** (2013.01 - EP); **E04F 15/02038** (2013.01 - EP); **E04F 15/02188** (2013.01 - EP); **E04F 15/04** (2013.01 - KR); **E04F 15/102** (2013.01 - EP); **E04F 15/107** (2013.01 - EP); **E04F 15/181** (2013.01 - EP); **E04F 15/206** (2013.01 - EP); **E04F 2201/0115** (2013.01 - EP); **E04F 2201/0153** (2013.01 - EP); **E04F 2201/07** (2013.01 - EP); **E04F 2290/042** (2013.01 - EP)

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SI

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